### Thermal stresses on the rotating target wheel

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### The Geometry

#### The current geometry being analysed

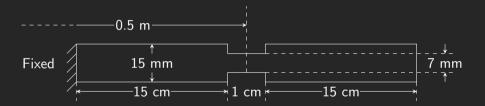


Figure 1: Cross section of the target wheel being analysed (Figure Not To Scale)

The Model

- Currently only a steady state analysis was done so the pulsed beam is modelled as a 2.07 kW power source
- The heat distribution is modelled as a Gaussian with peak at r = 0.5 m. The diameter of the beam spot ( $\sigma$ ) is set to 1.325 mm.
- Two methods of heat distribution are used
  - As heat flux on top surface.
  - As a heat source on the 7 mm thickness.

- Radiative Cooling with a water cooled cooler is used.
- Power Radiated is calculated as:

$$P = \sigma \epsilon A (T^4 - T_c^4)$$

 Effective emissivity(ε) is calulated from disc emissivity(ε<sub>d</sub>) and cooler emissivity(ε<sub>c</sub>) as:

$$\epsilon = rac{\epsilon_{d} * \epsilon_{c}}{1 - (1 - \epsilon_{d}) \left(1 - \epsilon_{c}
ight)}$$

• Both  $\epsilon_d \& \epsilon_c$  are set to 0.5 and cooler temperatue  $(T_c)$  is maintained at 293.15K.

# Preliminary Results

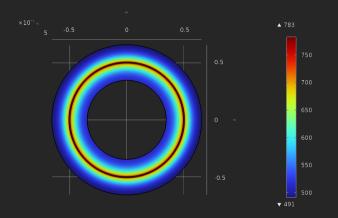


Figure 2: Temperatue Variation on Disc (Temperature in Kelvin)

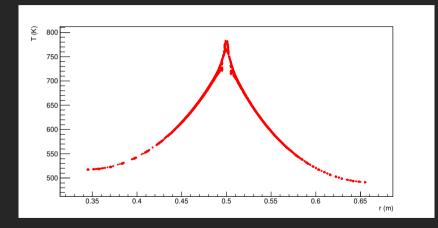


Figure 3: Temperatue variation with radius

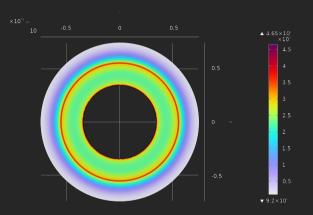


Figure 4: Von Mises Stresses on the Disc

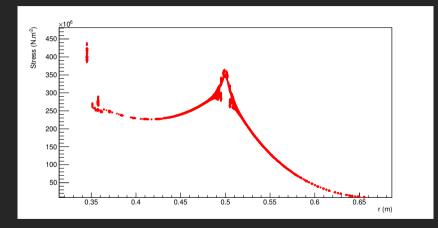


Figure 5: Von Mises Stress as function of radius

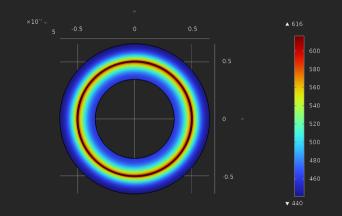


Figure 6: Temperatue Variation on Disc (Temperature in Kelvin)

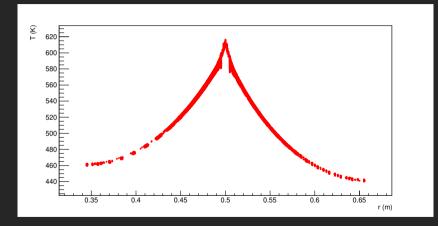


Figure 7: Temperatue variation with radius

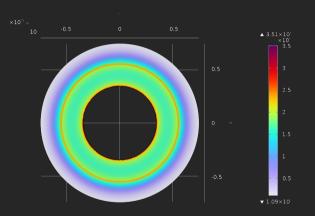


Figure 8: Von Mises Stresses on the Disc

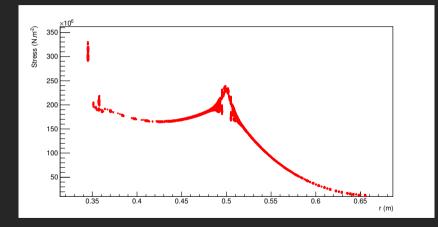


Figure 9: Von Mises Stress as function of radius

### Conclusions

- As a counter-intuitive fact, we see that the heat distribution profile has significant effect on the final outcomes. More analysis is required to properly model it.
- All of the material properties should be modelled as a function of temperature. The final outcomes are very highly variable with material properties.
- Expansion slots can be used to reduce stresses. Further analysis Required.

## Thank You!